ROHS



Vishay General Semiconductor

Surface Mount Ultrafast Rectifier

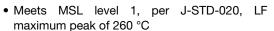


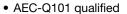
DO-214AB (SMC)

PRIMARY CHARACTERISTICS				
I _{F(AV)}	3.0 A			
V_{RRM}	100 V, 150 V, 200 V			
I _{FSM}	80 A			
t _{rr}	25 ns			
V_F at $I_F = 3.0 A$	0.75 V			
T _J max.	175 °C			

FEATURES

- Low profile package
- · Ideal for automated placement
- Oxide planar chip junction
- · Ultrafast recovery times for high frequency





 Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in secondary rectification and freewheeling for ultrafast switching speeds of AC/AC and DC/DC converters in high temperature conditions for both consumer and automotive applications.

MECHANICAL DATA

Case: DO-214AB (SMC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade Base P/NHE3 - RoHS-compliant, AEC-Q101 qualified Base P/NHE3_X - RoHS-compliant and AEC-Q101 qualified ("_X" denotes revision code e.g. A, B,)

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	UH3B	UH3C	UH3D	UNIT
Device marking code		НВ	HC	HD	
Maximum repetitive peak reverse voltage	V _{RRM}	100	150	200	V
Maximum average forward rectified current (fig. 1)	I _{F(AV)} (1)	2.5			А
	I _{F(AV)} (2)	3.0			
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	80			А
Operating junction and storage temperature range	T _J , T _{STG}	- 55 to + 175			°C

Notes

- (1) Free air, mounted on recommended copper pad area
- (2) Units mounted on PCB with 0.31" x 0.31" (8.0 mm x 8.0 mm) copper pad area



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 1.5 A	T _A = 25 °C	V _F ⁽¹⁾	0.85	-	V
	I _F = 3.0 A	1A = 23 C		0.95	1.05	
	I _F = 1.5 A	T _A = 125 °C		0.65	-	
	I _F = 3.0 A	1A = 123 C		0.75	0.90	
Reverse current	Rated V _R	$T_A = 25 ^{\circ}\text{C}$ $T_A = 125 ^{\circ}\text{C}$ $I_R^{(2)}$	I _R ⁽²⁾	ı	5	μА
	nateu v _R			15	100	
Maximum reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A},$ $I_{rr} = 0.25 \text{ A}$	- T _A = 25 °C	+	14	25	ns
Typical reverse recovery time	$I_F = 1.0 \text{ A}, \text{ dI/dt} = 50 \text{ A/}\mu\text{s}, \\ V_R = 30 \text{ V}, I_{rr} = 0.1 I_{RM}$		t _{rr}	23	40	115
Typical softness factor (t _b /t _a)			S	0.2	-	
Typical reverse recovery current	$I_F = 3.0 \text{ A}, \text{ dI/dt} = 200 \text{ A/}\mu\text{s}, V_B = 200 \text{ V}$	T _A = 125 °C	I _{RM}	5.0	7.0	Α
Typical stored charge	'n 200 '		Q _{rr}	60	-	nC
Typical junction capacitance	4.0 V, 1 MHz		CJ	42	-	pF

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	UH3B	UH3C	UH3D	UNIT
Typical thermal resistance	R _{0JA} (1)	95			°C/W
	R _{0JM} ⁽¹⁾		12		C/VV

Note

(1) Free air, mounted on recommended copper pad area. Thermal resistance $R_{\theta JA}$ - junction to ambient, $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
UH3D-E3/57T	0.236	57T	850	7" diameter plastic tape and reel		
UH3D-E3/9AT	0.236	9AT	3500	13" diameter plastic tape and reel		
UH3DHE3/57T (1)	0.236	57T	850	7" diameter plastic tape and reel		
UH3DHE3/9AT (1)	0.236	9AT	3500	13" diameter plastic tape and reel		
UH3DHE3_A/H (1)	0.236	Н	850	7" diameter plastic tape and reel		
UH3DHE3_A/I (1)	0.236	I	3500	13" diameter plastic tape and reel		

Note

(1) AEC-101 qualified

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RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

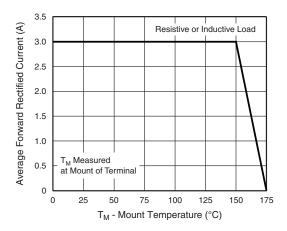


Fig. 1 - Maximum Forward Current Derating Curve

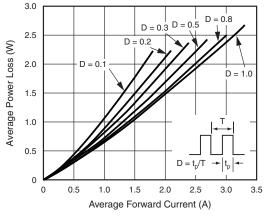


Fig. 2 - Forward Power Loss Characteristics

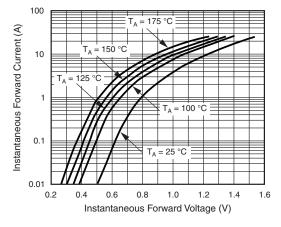


Fig. 3 - Typical Instantaneous Forward Characteristics

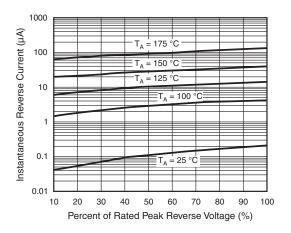


Fig. 4 - Typical Reverse Characteristics

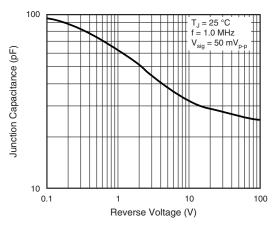


Fig. 5 - Typical Junction Capacitance

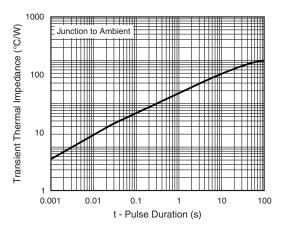


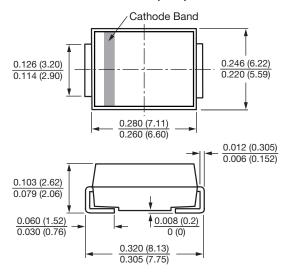
Fig. 6 - Typical Transient Thermal Impedance



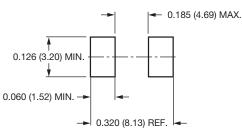
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AB (SMC)



Mounting Pad Layout





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Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

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